

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JINQUAN XU	06/02/2014
RECEIVING PARTY DATA	
Name:	UNITED TECHNOLOGIES CORPORATION
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City:	HARTFORD
State/Country:	CONNECTICUT
Postal Code:	06101
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14706685
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ATTORNEY DOCKET NUMBER:	PA-0026992-US-AA
NAME OF SUBMITTER:	RICHARD D. GETZ
SIGNATURE:	/rdg/
DATE SIGNED:	05/07/2015
Total Attachments: 2	
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ASSIGNMENT

THIS INSTRUMENT OF ASSIGNMENT WITNESSETH THAT:

WHEREAS, I, JinQuan Xu, resident of 30 Frederick T. Miller Way, East Greenwich, RI 02818 have invented improvements in

**METHOD FOR FORMING A DIRECTIONALLY SOLIDIFIED
REPLACEMENT BODY FOR A COMPONENT
USING ADDITIVE MANUFACTURING**

for which we executed an application for United States Letters Patent on even date herewith; and

WHEREAS, United Technologies Corporation, a Delaware corporation, having a place of business at 1 Financial Plaza, Hartford, CT 06101, is desirous of acquiring an interest in said invention, said application and the Letters Patent to be issued therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for and in consideration of the sum of ONE DOLLAR to each in hand paid and other good and valuable consideration, the receipt whereof is hereby acknowledged, we have sold, assigned and set over, and do hereby sell, assign and set over to said corporation, its successors or assigns, the entire right, title and interest to and in said invention in the United States and in all countries foreign to the United States, said United States application for Letters Patent therefor and in any non-provisional application that may claim said invention or priority to said application, and any divisional, continuation, and/or continuation-in-part thereof, and the Letters Patent when issued; and we do hereby authorize and request the Commissioner of Patents and Trademarks to issue the Letters Patent based upon said application to said corporation as the assignees of our entire right, title and interest to and in the same, for the sole use and behoof of said corporation, its successors or assigns.

And we also hereby covenant and agree to sign all proper papers including divisional and other applications for patents and assignments thereof in the United States and application for patents and assignments in all countries foreign to the United States, and to

execute all rightful oaths and to take any other proper action that may in the judgment of the said corporation be necessary for securing thereto full rights to said invention, all of the foregoing to be at the expense of said corporation.

IN TESTIMONY WHEREOF, I have hereunto set my hand this

2nd day of June, 2014.



JinQuan Xu



Witness: